

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

| | and the same of th | | | A LA |
|--------------------------|--|----------------------|------------------------------|--|
| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
| 09/490,705 | 01/24/2000 | Kazuyoshi Ueno | NECV-16.966 | 7525 |
| | 7590 03/07/2002 | | | |
| Helfgott & Karas P. C. | | | EXAMINER | |
| Empire Sta 60th Floor | | , | TRAN, THIEN F | |
| New York, | NY 10118-0110 | | ART UNIT | PAPER NUMBER |
| | | | 2811 DATE MAILED: 03/07/2002 | |
| | | | | |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | | Lie_ | | | | |
|--|--|--|--|--|--|--|
| | Application N . | Applicant(s) | | | | |
| | 09/490,705 | UENO, KAZUYOSHI | | | | |
| Office Action Summary | Examiner | Art Unit | | | | |
| | Thien F Tran | 2811 | | | | |
| Th MAILING DATE f this communication apportant for Reply | ears on the cover she t with the c | orrespondence address | | | | |
| A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply if NO period for reply is specified above, the maximum statutory period w. Failure to reply within the set or extended period for reply will, by statute, any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). Status | 6(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) days ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI | nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133). | | | | |
| 1) Responsive to communication(s) filed on | <u> </u> | | | | | |
| 2a)⊠ This action is FINAL . 2b)□ Thi | s action is non-final. | | | | | |
| 3) Since this application is in condition for allowa closed in accordance with the practice under EDisposition of Claims | | | | | | |
| 4)⊠ Claim(s) 1-11 is/are pending in the application. | | • | | | | |
| 4a) Of the above claim(s) <u>2-11</u> is/are withdrawn | | . • | | | | |
| 5) Claim(s) is/are allowed. | Trom conclusion. | | | | | |
| 6)⊠ Claim(s) 1 is/are rejected. | • | | | | | |
| 7) Claim(s) is/are objected to. | | | | | | |
| 8) Claim(s) are subject to restriction and/or | election requirement | | | | | |
| Application Papers | clockon requirement. | | | | | |
| 9) The specification is objected to by the Examiner | | | | | | |
| 10) The drawing(s) filed on is/are: a) accep | | miner. | | | | |
| Applicant may not request that any objection to the | • | | | | | |
| 11) ☑ The proposed drawing correction filed on <u>03 December 2001</u> is: a) ☑ approved b) ☐ disapproved by the Examiner. | | | | | | |
| If approved, corrected drawings are required in rep | ly to this Office action. | | | | | |
| 12) The oath or declaration is objected to by the Exa | aminer. | | | | | |
| Priority under 35 U.S.C. §§ 119 and 120 | | •, | | | | |
| 13) Acknowledgment is made of a claim for foreign | priority under 35 U.S.C. § 119(a |)-(d) or (f). | | | | |
| a) ☐ All b) ☐ Some * c) ☐ None of: | | · | | | | |
| 1. Certified copies of the priority documents | have been received. | | | | | |
| 2. Certified copies of the priority documents | s have been received in Applicati | on No | | | | |
| 3. Copies of the certified copies of the prior application from the International Bur * See the attached detailed Office action for a list of | eau (PCT Rule 17.2(a)). | | | | | |
| 14) Acknowledgment is made of a claim for domestic | c priority under 35 U.S.C. § 119(e | e) (to a provisional application). | | | | |
| a) The translation of the foreign language pro- | | | | | | |
| Attachment(s) | | | | | | |
| 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) | 5) Notice of Informal F | r (PTO-413) Paper No(s) Patent Application (PTO-152) | | | | |
| S. Patent and Trademark Office | | | | | | |

Application/Control Number: 09/490,705

Art Unit: 2811

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 1 is rejected under 35 U.S.C. 103(a) as being unpatentable over the Foote et al. (US 6,114,235) in view of Wetzel (US 6,143,646).

Foote et al. discloses a semiconductor device (Figs. 1e) comprising a substrate 12, on a main surface of which, an interconnect layer 14 is formed along with a predetermined pattern in buried condition in the substrate; an etching-stop layer 16 formed on the main surface of the substrate; and an insulation layer 18 formed on the etching-stop layer, the semiconductor device further comprises a single damascene structure via hole (24, 26) provided on a main surface of the insulation layer and penetrating through the insulation layer and the etching-stop layer so that a bottom of the via hole reaches at a surface of the interconnect layer, and a barrier layer 30 continuously covering the main surface of the insulation layer, an inside wall surface of the via hole and the surface of the interconnect layer integratedly. Foote et al. does not disclose the interconnect layer 14 made of copper. Wetzel discloses a semiconductor device (Fig. 26) with a copper interconnect layer 502 formed in buried condition in the substrate 500. It would have been obvious to a person having ordinary skill in the art at the time the invention was made to form the interconnect layer 14 of Foote et al. of

Application/Control Number: 09/490,705

Art Unit: 2811

copper as taught by Wetzel since copper can be formed at relatively low cost and provides low resistivity interconnects.

Response to Arguments

Applicant's arguments with respect to claim 1 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Reference B is being cited since it shows a semiconductor device comprising a substrate, on a main surface of which, an interconnect layer is formed along with a predetermined pattern in buried condition in the substrate; an etching-stop layer formed on the main surface of the substrate; and an insulation layer formed on the etching-stop layer. Reference D is being cited since it shows the advantage that copper interconnects provide in a semiconductor device.

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

Application/Control Number: 09/490,705

Art Unit: 2811

the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thien F Tran whose telephone number is (703) 308-4108. The examiner can normally be reached on 7:00AM - 3:30PM Monday through Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (703) 308-2772. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

TOM THOMAS SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800

tt February 21, 2002